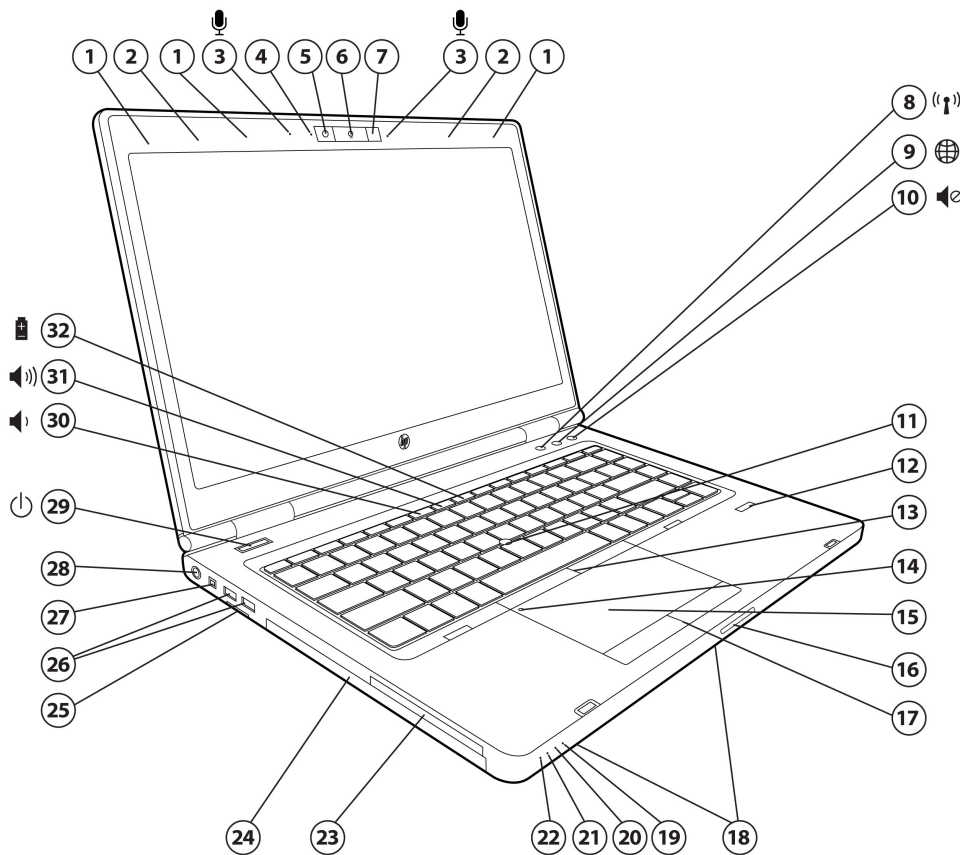


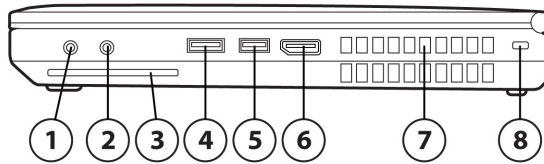
Overview



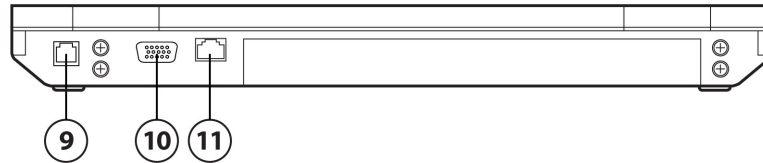
- | | |
|--|--|
| 1. WLAN antennas (3) | 17. Touchpad pick buttons |
| 2. WWAN antennas | 18. Stereo speakers (see bottom view) |
| 3. Dual-microphone array | 19. Hard drive activity / HP 3D DriveGuard LED indicator |
| 4. Webcam LED indicator (with optional webcam) | 20. Battery charging LED indicator |
| 5. Optional 720p HD webcam | 21. Power/standby LED indicator |
| 6. HP Night Light on button | 22. Wireless on/off LED indicator |
| 7. HP Night Light | 23. ExpressCard/54 slot |
| 8. Wireless on/off button with LED indicator | 24. Upgrade Bay (optical drive, second hard drive or weight saver) |
| 9. HP Web Browser button with LED indicator | 25. Secure Digital slot |
| 10. Volume mute button with LED indicator | 26. (2) USB 3.0 ports |
| 11. Pointstick | 27. 1394a port |
| 12. Optional HP Fingerprint Sensor | 28. Power connector |
| 13. Pointstick pick buttons | 29. Power button with LED indicator |
| 14. Touchpad on/off button with LED indicator | 30. Volume down function key |
| 15. Touchpad with scroll zone | 31. Volume up function key |
| 16. Display release latch | 32. HP Power Assistant function key |

Overview

Right View

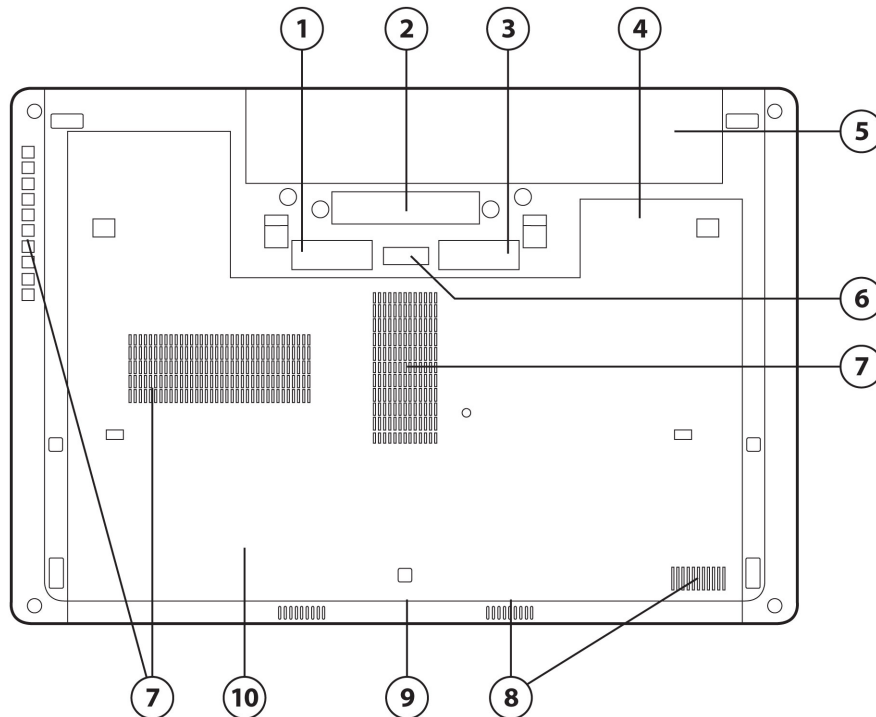


Rear View



- | | |
|---------------------------------|------------------------------------|
| 1. Stereo headphone/line out | 7. Vents |
| 2. Stereo microphone/line in | 8. Security lock slot |
| 3. Integrated Smart Card reader | 9. RJ-11/modem port (optional) |
| 4. eSATA/USB 2.0 combo port | 10. VGA/external monitor connector |
| 5. USB 2.0 charging port | 11. RJ-45/Ethernet port |
| 6. DisplayPort | |

Bottom View

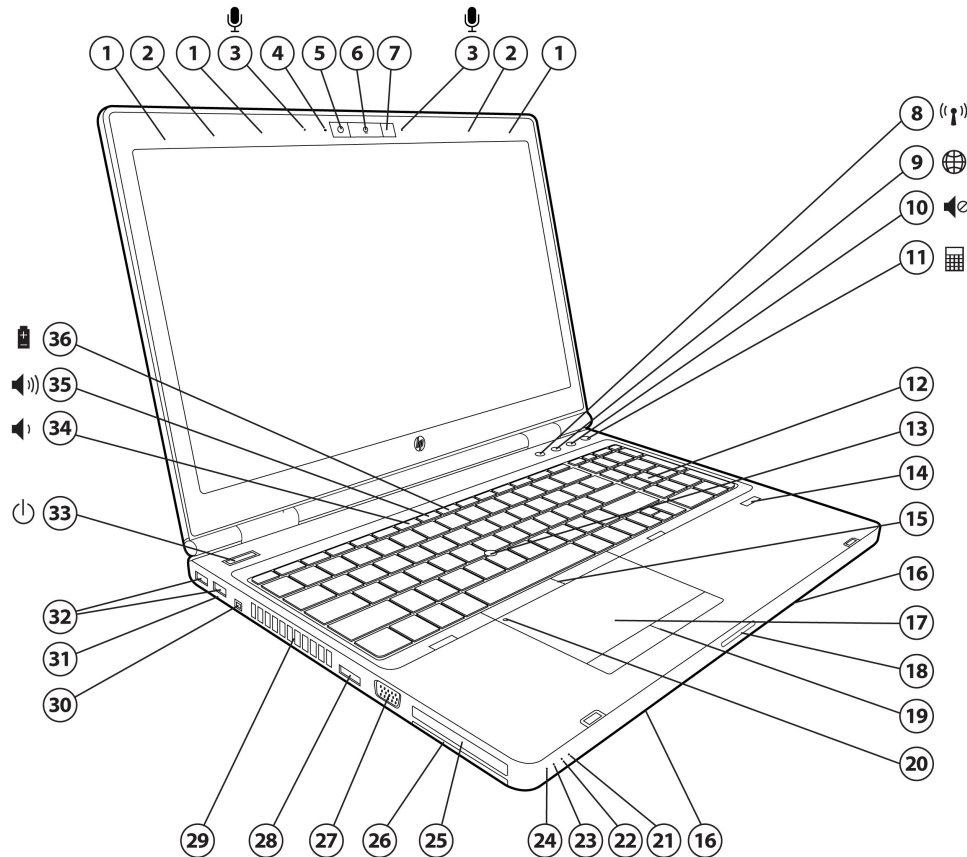


- | | |
|--|--|
| 1. Battery release latch | 6. Secondary battery connector |
| 2. Docking connector | 7. Vents |
| 3. Bottom cover release latch | 8. Speakers |
| 4. SIM slot for WWAN (in battery bay; select models) | 9. Bluetooth module compartment under bottom cover |

Overview

5. Battery bay
10. Hard drive, memory, and wireless compartment under bottom cover

HP EliteBook 8570p Notebook PC



- | | |
|--|--|
| 1. WLAN antennas (3) | 19. Touchpad with scroll zone |
| 2. WWAN antennas | 20. Touchpad on/off light |
| 3. Dual-microphone array | 21. Hard drive activity / HP 3D DriveGuard LED indicator |
| 4. Webcam LED indicator (with optional webcam) | 22. Battery charging LED indicator |
| 5. Optional 720p HD webcam | 23. Power/standby LED indicator |
| 6. HP Night Light on button | 24. Power/standby LED indicator |
| 7. HP Night Light | 25. ExpressCard/54 slot |
| 8. Wireless on/off button with LED indicator | 26. Smart Card Reader |
| 9. HP Web Browser button with LED indicator | 27. VGA/external monitor connector |
| 10. Volume mute button with LED indicator | 28. eSATA/USB 2.0 combo port |
| 11. Calculator button with LED indicator | 29. Vent |
| 12. Numeric keypad | 30. 1394a port |
| 13. Pointstick | 31. Secure Digital slot |
| 14. Optional HP Fingerprint Sensor | 32. (2) USB 2.0 ports* |
| 15. Pointstick pick buttons | 33. Power button with LED indicator |
| 16. Stereo speakers | 34. Volume down function key |

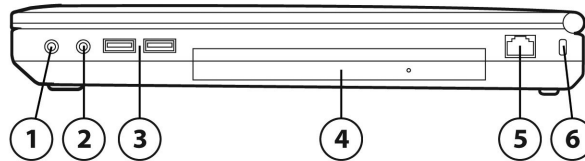
Overview

- 17. Display release latch
- 18. Touchpad pick buttons

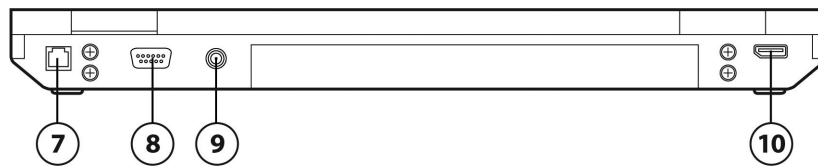
* USB 2.0 port on right is a charging port.

- 35. Volume up function key
- 36. HP Power Assistant function key

Right View

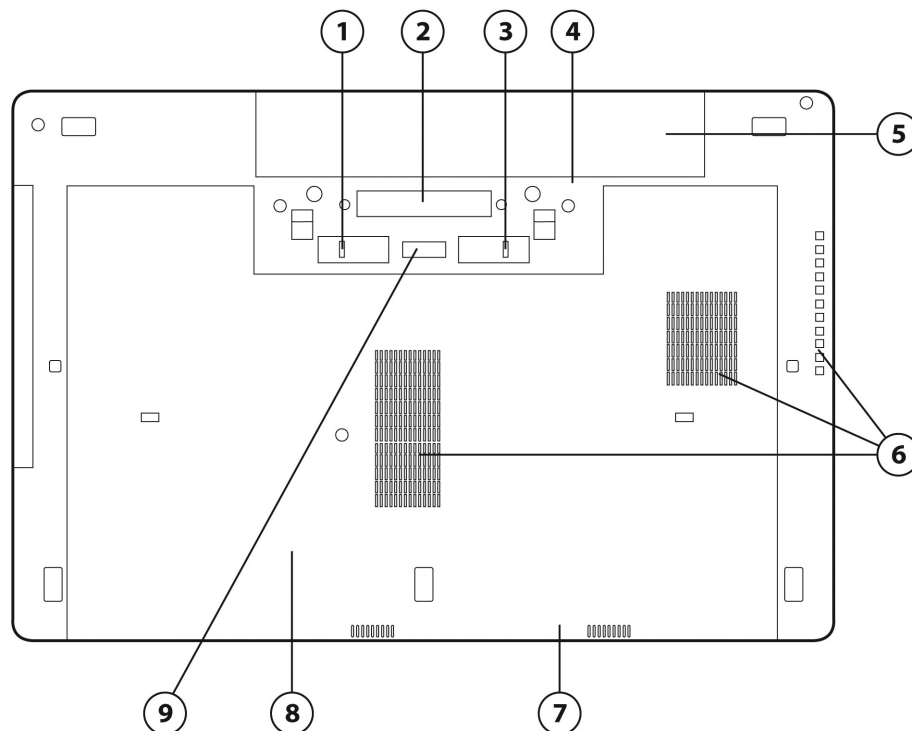


Rear View



- | | |
|---|--------------------------------|
| 1. Stereo headphone/line out | 6. Security lock slot |
| 2. Stereo microphone/line in | 7. RJ-11/modem port (optional) |
| 3. (2) USB 3.0 ports | 8. Serial port |
| 4. Upgrade Bay (optical drive, second hard drive or weight saver) | 9. Power connector |
| 5. RJ-45/Ethernet port | 10. DisplayPort |

Bottom View



- | | |
|--------------------------|---------------------------------|
| 1. Battery release latch | 6. Vents |
| 2. Docking connector | 7. Bluetooth module compartment |

Overview

3. Bottom cover release latch
4. SIM slot for WWAN (in battery bay; select models)
5. Battery bay
8. Hard drive, memory, and wireless compartments under bottom cover
9. Secondary battery connector

At A Glance

- Windows 8 versions, Windows 7 versions or FreeDOS
- Aluminum display enclosure, magnesium-reinforced chassis, wear-resistant platinum-colored HP DuraFinish, HP DisplaySafe frame, precision aluminum-alloy hinges, cast titanium-alloy display latches, keyboard in full aluminum deck, and chemically strengthened glass touchpad; designed to meet the military standard Mil-Std-810G for vibration, dust, altitude, and high temperature operation
- Choice 3rd Generation Intel® Core™ i7 Quad-Core with Turbo Boost Technology; 3rd Generation Intel Core™ i7 and i5 Dual-Core with Turbo Boost Technology
- Intel Core i7 with vPro™ and Core i5 with vPro technology (optional)
- AMD Radeon™ HD 7570M discrete graphics with 1 GB dedicated GDDR5 video memory or integrated Intel® HD Graphics 4000
- Widescreen LED-backlit display
 - HP EliteBook 8470p: 14.0-inch diagonal HD or HD+
 - HP EliteBook 8570p: 15.6-inch diagonal HD or FHD wide viewing angle
- Easily hot dock with one of the optional HP docking stations
- DisplayPort for high resolution support
- SRS Premium Sound PRO optimized for high fidelity audio
- Choice of primary battery to optimize run-time or weight: 9-cell (100 WHr), 6-cell (62 WHr), or 6-cell (55 WHr) HP Long Life Battery
- Combine primary battery with optional secondary battery options
- Touchpad with scroll zone and pointstick; 8570p features a numeric keypad and calculator button
- Standard ExpressCard slot and integrated Smart Card Reader for strong security authentication
- Security features including HP Client Security (Windows 8 only) and HP ProtectTools, with central management across HP and non-HP client PCs
- " HP Peak Power Manager (web download) and HP Power Assistant (Windows 7 only) allow you to conserve power, stretch battery run-time, accurately monitor the energy usage of the PC and up to four select HP external monitors, and report workforce power consumption.
- Flexible wireless connectivity options:
 - Optional integrated HP hs2350 HSPA+ Mobile Broadband Module connects to both HSPA and HSPA+ (UMTS) networks and provides GPS functionality
 - Optional integrated HP un2430 EV-DO/HSDPA Mobile Broadband Module (Gobi™ 3000)
 - Integrated Intel Centrino® 802.11 a/b/g/n 3x3 and 2x2, Broadcom 802.11 a/b/g/n 2x2, or Atheros b/g/n 1x1 wireless LAN module
 - Bluetooth® v4.0+EDR
- Upgrade Bay for optical drive, optional second hard drive, or weight saver
- Choice of 7200 rpm user-removable hard drive (up to 750 GB) with HP 3D DriveGuard, 500 GB 7200 rpm Self Encrypting Drive (SED) (8570p only), 128 GB Solid State Drive (8570p only), 180 GB Solid State Drive (available starting June 2012), or 256 GB SED Solid State Drive (8570p only)
- Low Halogen*, ENERGY STAR qualified (with Microsoft OS) and EPEAT Gold registered in the U.S. (with Microsoft OS). EPEAT status varies by country- please see epeat.net.

* Meeting the industry definition of 'Low Halogen' per the iNEMI Position Statement on "Low Halogen" Electronics. Plastic parts incorporated into the chassis generally contain < 1000 ppm (0.1%) of bromine or chlorine. Printed circuit board and substrate laminates generally contain < 1500 ppm (0.15%) of total bromine and chlorine. Service parts after purchase may not be Low Halogen. External accessories, including power supplies, power cords, and peripherals as well as the following customer-configurable internal component: ATT SIM card, are not Low Halogen.

Overview

OPERATING SYSTEM

Preinstalled	Windows 8 Pro 64* Windows 7 Professional (available through downgrade rights from Windows 8 Pro)** Windows 8 64* Windows 7 Professional 32*** Windows 7 Professional 64*** Windows 7 Home Premium 32*** (8470p, select countries) Windows 7 Home Premium 64*** (select countries) Windows 7 Home Basic 32*** (select countries) FreeDOS
Supported	Windows 8 Pro 32* Windows 8 32* Windows 8 Enterprise 32* Windows 8 Enterprise 64* Windows 7 Enterprise 32*** Windows 7 Enterprise 64*** Windows 7 Ultimate 32*** Windows 7 Ultimate 64*** Windows XP Professional 32
Certified	SUSE Linux Enterprise Desktop 11

* Not all features are available in all editions of Windows 8. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8 functionality. See <http://www.microsoft.com> for details.

** This system is preinstalled with Windows® 7 Pro software and also comes with a license and media for Windows 8 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

*** Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality. See <http://www.microsoft.com/windows/windows-7/> for details.

PROCESSOR

- 3rd Generation Intel® Core™ i7-3740QM (2.70 GHz, 6 MB L3 cache, 45W, 4 cores)*
Up to 3.70 GHz with Intel Turbo Boost Technology
- 3rd Generation Intel® Core™ i7-3720QM (2.60 GHz, 6 MB L3 cache, 45W, 4 cores)* (8570p only)
Up to 3.60 GHz with Intel Turbo Boost Technology
- 3rd Generation Intel® Core™ i7-3630QM (2.40 GHz, 6 MB L3 cache, 45W, 4 cores)*†
Up to 3.40 GHz with Intel Turbo Boost Technology
- 3rd Generation Intel® Core™ i7-3610QM (2.30 GHz, 6 MB L3 cache, 45W, 4 cores)* (8570p only)†
Up to 3.30 GHz with Intel Turbo Boost Technology
- 3rd Generation Intel® Core™ i7-3520M (2.90 GHz, 4 MB L3 cache, 35W, 2 cores)*
Up to 3.60 GHz with Intel Turbo Boost Technology
- 3rd Generation Intel® Core™ i5-3360M (2.80 GHz, 3 MB L3 cache, 35W, 2 cores)*
Up to 3.50 GHz with Intel Turbo Boost Technology
- 3rd Generation Intel® Core™ i5-3320M (2.60 GHz, 3 MB L3 cache, 35W, 2 cores)*
Up to 3.30 GHz with Intel Turbo Boost Technology
- 3rd Generation Intel® Core™ i5-3210M (2.50 GHz, 3 MB L3 cache, 35W, 2 cores)* (8570p only)†
Up to 3.10 GHz with Intel Turbo Boost Technology

* Multi-Core is designed to improve performance of certain software products. Not all customers or software applications will

Features

necessarily benefit from use of this technology. 64-bit computing on Intel® architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processors will not operate (including 32-bit operation) without an Intel® 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. Intel's numbering is not a measurement of higher performance.

NOTE: Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
† Not available with vPro

CHIPSET

Mobile Intel QM77 Express (vPro support)

INTEL CORE I5 WITH VPRO/CORE I7 WITH VPRO TECHNOLOGY CAPABLE

Intel Core i5 with vPro and Core i7 with vPro technology is a selectable feature that is available on units configured with select processors, an Intel Centrino® Advanced-N or Ultimate-N WLAN module and a preinstalled Windows operating system. It provides advances in remote manageability, security, energy efficient performance, and wireless connectivity. Intel Active Management Technology 8.0 (iAMT) offers built-in manageability and proactive security for networked notebook PCs, even when they are powered off* or when the operating system is inoperable. It can help identify threats before they reach the network, isolate infected systems, and update PCs regardless of their power state.

*Requires a Windows operating system, network hardware and software, connection with a power source, and a direct (non-VPN) corporate network connection which is either cable or wireless LAN.

NOTE: Some functionality of Intel Core i5 with vPro/Core i7 with vPro technology, such as Intel Active Management technology and Intel Virtualization technology, requires additional third- party software in order to run. Availability of future "virtual appliances" applications for Intel Core i5 with vPro/Core i7 with vPro technology is dependent on third- party software providers. Compatibility with future "virtual appliances" is yet to be determined.

GRAPHICS

Integrated:

Intel HD Graphics 4000

Microsoft® DirectX®, OpenGL 3.1, OpenCL 1.1, and CUI 4.0

Discrete:

AMD Radeon™ HD 7570M, with 1 GB dedicated GDDR5 video memory

Microsoft® DirectX® 11 with Shader Model 5.0 and support for OpenGL 4.1.

Features

DISPLAY

HP EliteBook 8470p:

Internal

14.0" diagonal LED-backlit HD 16:9 widescreen anti-glare (1366 x 768)

14.0" diagonal LED-backlit HD+ 16:9 widescreen anti-glare (1600 x 900)

HP Privacy Filter support

External

Up to 32-bit per pixel color depth

DisplayPort

Supports resolutions up to 2560 x 1600, 30-bit color depth at 60 Hz, and full HD (1920 x 1080) monitors, 24-bit color depth at 120 Hz

VGA

Port supports resolutions up to 2048 x 1536 at 75 Hz, and lower resolutions at up to 100 Hz

DVI-D (single link)

Video signal available through DVI port in optional HP Docking Station (sold separately)

supports resolutions up to 1600 x 1200 at both full and reduced blanking, and 1920 x 1200 at reduced blanking

HP EliteBook 8570p:

Internal

15.6" diagonal LED-backlit HD 16:9 anti-glare (1366 x 768)

15.6" diagonal LED-backlit FHD WVA anti-glare (1920 x 1080)

HP Privacy Filter support

External

Up to 32-bit per pixel color depth

DisplayPort

Supports resolutions up to 2560 x 1600, 30-bit color depth at 60 Hz, and full HD (1920 x 1080) monitors, 24-bit color depth at 120 Hz

VGA

Port supports resolutions up to 2048 x 1536 at 75 Hz, and lower resolutions at up to 100 Hz

DVI-D (single link)

Video signal available through DVI port in optional HP Docking Station (sold separately)

supports resolutions up to 1600 x 1200 at both full and reduced blanking, and 1920 x 1200 at reduced blanking

NOTE: Resolutions are dependent upon monitor capability, and resolution and color depth settings.

Features

STORAGE AND DRIVES

Primary Storage Bay

Hard Drives

320/500/750 GB 7200 rpm SMART SATA II

500 GB 7200 rpm SMART SATA II Self Encrypting Drive (8570p only)

HP 3D DriveGuard (Windows only)

The hard drive is mounted directly to the notebook frame, reducing the transmission of shock to the hard drive.

Solid State Drive

SATA 6 Gb/s 128 GB Solid State (8570p only)

SATA 6 Gb/s 180 GB Solid State (Available starting June 2012)*

SATA 6 Gb/s 256 GB SED Solid State

* Not offered in Brazil.

NOTE: For hard drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 16GB (for Windows 7) of system and up to 30 GB (for Windows 8) disk is reserved for system recovery software.

OPTICAL DRIVES

Fixed 12.7 mm SATA optical drive

Blu-ray ROM DVD+/-RW SuperMulti DL Drive (8570p only)

DVD+/-RW SuperMulti DL Drive

DVD-ROM Drive

Second hard drive

500 GB 7200 rpm SMART SATA II Hard Drive

Weight saver

MEMORY

Standard

DDR3 PC3-12800 SDRAM (1600 MHz)

Two SODIMM slots supporting dual-channel memory

Standard memory up to 8192 MB (2 GB, 4 GB, and 8 GB SODIMMs)

Maximum

16384 MB

Dual-channel

Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory slots.

NOTE: Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed. With Windows Starter 32-bit operating systems, the amount of usable memory is dependent upon your configuration, so that above 3 GB all memory may not be available due to system resource requirements.

Features

NETWORKING/COMMUNICATIONS

Wireless

Support for a broad range of secure, integrated wireless LAN and wireless WAN options featuring support for the latest industry standards. Broadband Wireless (WWAN) requires a Windows operating system and is available in select countries. Wireless LAN and integrated Bluetooth are also available (both are factory configurable only) and can be combined with any of the supported wireless WAN options.

Broadband Wireless (WWAN) (Win 8 WWAN support will not be available at Win 8 introduction)

HP hs2350 HSPA+ Mobile Broadband Module

HP un2430 EV-DO/HSDPA Mobile Broadband Module (Gobi™ 3000)

HP lt2522 LTE/EV-DO Mobile Broadband Module – U.S. only* (no Win 8 support)

HP lt2523 LTE/HSPA+ Mobile Broadband Module – U.S. only* (no Win 8 support)

Integrated wireless LAN options

Intel Centrino Ultimate-N 6300 802.11a/b/g/n (3x3)

Intel Centrino Advanced-N 6205 802.11a/b/g/n (2x2)

802.11 a/b/g/n WiFi Adapter (2x2)

802.11 b/g/n WiFi Adapter (1x1) (8570p only)

HP Integrated Module with Bluetooth 4.0+ EDR Wireless Technology

Communications

Integrated Intel 82579LM Gigabit** Network Connection (vPro configurations)

56K V.92 modem***

* Wireless use requires separately purchased service contract. Check with your local vendor for coverage area and availability in your area. Connection and speeds will vary due to location, environment, network conditions, and other factors. 4G compatibility with HSPA+ and LTE. 4G LTE is only available in the United States and requires Windows 7.

** The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

*** Designed for downloads from 56K modem compliant sources. Maximum achievable download transmission rates currently do not reach 56 KB/s, and will vary with line conditions. Modem availability is subject to country regulatory approval.

AUDIO/MULTIMEDIA

Audio

SRS Premium Sound PRO™

Integrated stereo speakers

Integrated dual-microphone array

Button for volume mute; function keys for volume up and down

Stereo headphone port

Stereo microphone port

Webcam

Optional 720p HD webcam

- HD format (widescreen)
- Supports videoconferencing and still image capture
- High quality fixed focus lens
- Video capture at various resolutions up to 1280x720 resolution (720p) and up to 30fps
- M-JPEG compression supports higher frame rates for video capture and videoconferencing
- Improved low light sensitivity

Features

- Improved dynamic range

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

The HP spill-resistant keyboard is designed using a thin layer of Mylar film under the keyboard and a drain system that funnels fluid through a hole in the bottom of the notebook. This minimizes the risk of damage to sensitive components underneath. The 101/102-key compatible keyboard features a full-pitch key layout with desktop keyboard features, such as the isolated inverted-T cursor control keys, editing keys, both left and right control and alt keys, 12 function keys, and 19.05 x 19.05 mm key pitch (center-to-center spacing). U.S. and International key layouts are available. Other features include hot keys for instant access to power conservation and brightness. The HP EliteBook 8570p includes a separate numeric keypad.

Pointing Devices

Touchpad with on/off button, two-way scroll, gestures, two pick buttons

Pointstick with two additional pointstick buttons (for a total of four)

Buttons and Function Keys

Discrete buttons provide easy access to the following features: wireless on/off, Web browser, and volume mute. The HP EliteBook 8570p also features a calculator button. Function keys provide control of the following features: standby mode, external display, volume down, volume up, HP Power Assistant (Windows 7 only), and display brightness.

SOFTWARE AND SECURITY

Preinstalled Software with Windows Operating System

HP Connection Manager (Windows 7 only)
HP Hotkey Support
HP Peak Power Manager (web download)*
HP Power Assistant (Windows 7 only)
HP ProtectTools for Central Management
HP ProtectTools Security Manager
HP Recovery Manager
HP Support Assistant
HP Webcam Software (select models)
HP Wireless Hotspot (Windows 8 only, web download)
Adobe Flash Player (Windows 7 only)
Buy Office
Cyberlink Media Suite
Microsoft Defender (now includes MS Security Essentials)
Microsoft Security Essentials (Windows 7 only)
PDF Complete Corporate Edition
Skype-ready**
WinZip Basic (Windows 7 only)

NOTE: HP Recovery Manager enables fast recovery of the factory preinstalled image if the system becomes corrupted or if important system files are accidentally deleted. Up to 16GB (for Windows 7) of system and up to 30 GB (for Windows 8) disk is reserved for system recovery software. Support in Windows Operating System only.

* HP Peak Power Manager replaces HP Power Assistant for both Win7 and Win8. HP Peak Power Manager will be available on the web for download for existing product owners.

** Skype-ready. Skype is not offered in China.

Security

Features

Standard

HP Client Security Dashboard (Windows 8 only)
HP ProtectTools
HP Spare Key (requires initial user setup)
Central Management for HP ProtectTools
Credential Manager for HP ProtectTools
Drive Encryption (will be web-only ready at Win8 GA date)
Enhanced Pre-Boot Security
Face Recognition
File Sanitizer for HP ProtectTools (Windows 7 only)
Microsoft Defender (now includes MS Security Essentials)
Microsoft Security Essentials (Windows 7 only)
TPM Embedded Security Chip 1.2
Smart Card Reader
Security lock slot

Optional

Computrace (requires a subscription)
Intel Anti-Theft Technology (requires a Computrace subscription)
HP Fingerprint Sensor
HP Privacy Filter

NOTE: The Computrace agent is shipped turned off, and must be activated by customers when they purchase a subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S.

For more information on HP security solutions refer to: <http://www.hp.com/go/security>.

POWER

Power Supply

Models with discrete graphics and models with integrated graphics with quad-core processor:

External 90W HP Smart AC Adapter

Models with integrated graphics with dual-core processor:

External 65W HP Smart AC Adapter

Power cord included is 6-foot (1.8 meter).

Total length including external AC adapter is 12 feet (3.66 meter).

HP Fast Charge (not supported on 9-cell primary or secondary batteries)

Primary Battery

HP 9-cell Lithium-Ion Battery (100 WHr)

HP 6-cell Lithium-Ion Battery (62 WHr)

HP 6-cell HP Long Life Lithium-Ion Battery (55 WHr)

Secondary Battery

HP Extended Life Notebook Battery (9-cell /73 WHr)

HP Ultra Extended Life Notebook Battery (9-cell /100 WHr)

Battery Life*

HP EliteBook 8470p**

9-cell (100 WHr) Up to 14 hours and 15 minutes

6-cell (62 WHr) Up to 9 hours and 15 minutes

Features

with optional Up to 20 hours and 30 minutes
HP ST09 Extended Life
Notebook Battery

with optional Up to 24 hours and 15 minutes
HP BB09 Ultra Extended
Life Notebook Battery

HP EliteBook 8570p**

9-cell (100 WHr) Up to 13 hours and 30 minutes

6-cell (62 WHr) Up to 8 hours and 15 minutes

with optional Up to 18 hours and 45 minutes
HP ST09 Extended Life
Notebook Battery

with optional Up to 22 hours and 15 minutes
HP BB09 Ultra Extended
Life Notebook Battery

System Standby Time

Up to 30 days

*Battery life will vary depending on the product model, configuration, loaded applications, features, use, wireless functionality and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See MobileMark07 battery benchmark <http://www.bapco.com/products/mobilemark2007> for additional details.

** Configurations with integrated graphics.

NOTE: Fast Charge recharges your battery up to 90% within 90 minutes when the system is off. Please note that 9-cell batteries do not support Fast Charge.

Power Conservation

AMD PowerPlay technology (models with discrete graphics)
Hibernation
Standby
ACPI compliance

ENVIRONMENTAL

ENERGY STAR qualified (with Microsoft OS)

IT ECO Declaration

EPEAT Gold where HP registers commercial notebook products. See <http://www.epeat.net> for registration status in your country.

NOTE: This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks.

Features

WEIGHTS & DIMENSIONS

8470p

Weight

Starting at 4.56 lb (2.07 kg) without optical drive

Starting at 4.95 lb (2.25 kg) with DVD-ROM drive

Dimensions (w x d x h)

13.31 x 9.11 x 1.25 in (at front)

33.8 x 23.1 x 3.4 cm (at front)

8570p

Weight

Starting at 5.75 lb/2.61 kg (3-cell with weight saver)

Starting at 5.97 lb/2.71 kg (3-cell with optical drive)

Dimensions (w x d x h)

14.72 x 9.86 x 1.34 in (at front)

37.4 x 25.1 x 3.4 cm (at front)

NOTE: Height varies depending upon where on the notebook the measurement is made. Weight varies by configuration and components.

PORTS/SLOTS

Ports

8470p

VGA – One

DisplayPort – One (UMA: v1.1a; discrete: v1.2)

Stereo microphone port – One

Stereo headphone port – One

Power Connector – One

Secondary Battery Connector – One

Docking Connector – One

RJ-45 (Ethernet) – One

RJ-11 (Modem) – One

1394a – One

USB 3.0 – Two

USB 2.0 charging port – One

eSATA/USB 2.0 combo port – One

8570p

VGA – One

DisplayPort – One (UMA: v1.1a; discrete: v1.2)

Stereo microphone port – One

Stereo headphone port – One

Power Connector – One

Secondary Battery Connector – One

Docking Connector – One

RJ-45 (Ethernet) – One

RJ-11 (Modem) – One

1394a – One

USB 3.0 – Two

Features

USB 2.0 – One
USB 2.0 charging port – One
eSATA/USB 2.0 combo port – One
Serial port – One

Digital Media Slots

1 ExpressCard/54 slot
1 SD slot (supported media include: SD, SDHC, SDXC)

SERVICE AND SUPPORT

HP Services offers limited 3 year and 1 year warranty options depending on country; 1-year limited warranty on primary battery; 3-year limited warranty on HP Long Life Battery (only available with 3-year platform warranty). On-site service and warranty upgrades are also available. HP Care Pack Services extend service contracts beyond the standard warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: <http://www.hp.com/go/lookuptool>. Additional HP Care Pack Services information by product is available at: <http://www.hp.com/services/carepack>.

NOTE: Certain restrictions and exclusions apply. Consult the HP Customer Support Center for details.
<http://h20000.www2.hp.com/bizsupport/TechSupport/ProductRoot.jsp>

Technical Specifications

SYSTEM UNIT

Stand-Alone Power Requirements (AC Power)	Nominal Operating Voltage	18.5 V		
	Average Operating Power	HP EliteBook 8570p	Windows 7 (32-bit)	Windows 7 (64-bit)
		Integrated graphics	10.23 W	10.42 W
		Discrete graphics	13.5 W	13.88 W
		HP EliteBook 8470p		
		Integrated graphics	9.14 W	9.07 W
		Discrete graphics	13.62 W	13.31 W
	Max Operating Power	< 65 W or < 90 W		
Temperature	Operating	32° to 95° F (0° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (writing optical)		
	Non-operating	-4° to 140° F (-20° to 60° C)		
Relative Humidity	Operating	10% to 90%, non-condensing		
	Non-operating	5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature		
Shock	Operating	40 G, 2 ms, half-sine		
	Non-operating	200 G, 2 ms, half-sine		
Random Vibration	Operating	0.75 grms		
	Non-operating	1.50 grms		
Altitude (unpressurized)	Operating	-50 to 10,000 ft (-15.24 to 3,048 m)		
	Non-operating	-50 to 40,000 ft (-15.24 to 12,192 m)		
Planned Industry Standard Certifications	UL	Yes		
	CSA	Yes		
	FCC Compliance	Yes		
	ENERGY STAR®	Select models*		
	EPEAT	Registered Gold in United States**		
	ICES	Yes		
	Australia / NZ A-Tick Compliance	Yes		
	CCC	Yes		
	Japan VCCI Compliance	Yes		
	KC	Yes		
	BSMI	Yes		
	CE Marking Compliance	Yes		
	BNCI or BELUS	Yes		
	CIT	Yes		
	GOST	Yes		

Technical Specifications

Saudi Arabian Compliance (ICCP) Yes

SABS Yes

UKRSERTCOMPUTER Yes

* Configurations of the HP EliteBook 8470p and HP EliteBook 8570p that are ENERGY STAR qualified are identified as HP 8470p ENERGY STAR and HP 8570p ENERGY STAR on HP websites and on www.energystar.gov.

** EPEAT registration varies by country. See www.epeat.net for registration status by country. EPEAT status listed above applies to U.S.

For accessibility information on HP products, please visit: <http://www.hp.com/accessibility>.

DISPLAY

**14.0-inch LED HD
(1366 x 768)
anti-glare**

Dimensions (W x H)	12.74 x 7.56 in (32.4 x 19.2 cm)	
Diagonal Size	14.0 in (35.6cm)	
Surface Treatment	Anti-glare	
Contrast Ratio	300:1 (typical)	
Refresh Rate	60 Hz	
Brightness	200 nit (typical)	
Pixel Resolution	Pitch	0.227 mm
	Format	1366 x 768
	Configuration	RGB Stripe
Backlight	LED	
PPI	112 ppi	
Viewing Angle	±30° Horizontal, ±10° Vertical (minimum)	
	30/30/20/10 (Left/Right/Down/Up) (minimum) or	
	45/45/35/25 (Left/Right/Down/Up) (typical)	

Technical Specifications

14.0-inch LED HD+ (1600 x 900) anti-glare	Dimensions (W x H)	12.74 x 7.56 in (32.4 cm x 19.2 cm)	
	Diagonal Size	14.0 in (35.6cm)	
	Surface Treatment	Anti-glare	
	Contrast Ratio	300 (min)	
	Refresh Rate	60 Hz	
	Brightness	200 nits (typical)	
	Pixel Resolution	Pitch	0.1935mm
		Format	1600 x 900
		Configuration	RGB Stripe
	Backlight	LED	
	PPI	131 ppi	
	Viewing Angle	30/30/20/10 (Left/Right/Down/Up) (minimum)	

15.6-inch LED HD (1366 x 768) anti-glare	Dimensions (W x H)	13.54 x 7.59 in (34.4 x 19.4 cm)	
	Diagonal Size	15.6 in (39.6cm)	
	Surface Treatment	Anti-glare	
	Contrast Ratio	300:1 (typical)	
	Refresh Rate	60 Hz	
	Brightness	200 nit (typical)	
	Pixel Resolution	Pitch	0.252 mm
		Format	1366 x 768
		Configuration	RGB Stripe
	Backlight	LED	
	PPI	100 ppi	
	Viewing Angle	±30° Horizontal, ±10° Vertical (minimum) 30/30/20/10 (Left/Right/Down/Up) (minimum) or 45/45/35/25 (Left/Right/Down/Up) (typical)	

Technical Specifications

15.6-inch LED FHD WVA (1920 x 1080) anti-glare	Dimensions (W x H)	13.54 x 7.59 in (34.4 x 19.4 cm)	
	Diagonal Size	15.6 in (39.6 cm)	
	Surface Treatment	Anti-glare	
	Contrast Ratio	300 :1 (min)	
	Refresh Rate	60 Hz	
	Brightness	220 nits (Typ)	
	Pixel Resolution	Pitch	0.179mm x 0.179mm
		Format	1920 x 1080
		Configuration	RGB Stripe
	Backlight	White LED	
	PPI	142 ppi	
	Viewing Angle	±60° Horizontal, ± 50° Vertical (minimum) or ±70° Horizontal, ±60° Vertical (typical)	

STORAGE AND DRIVES

Internal Storage

750 GB 7200 rpm SATA Hard Drive	Drive Weight	0.22 lb (101 g)	
	Capacity	750 GB	
	Height	0.37 in (9.5 mm)	
	Width	2.75 in (70 mm)	
	Interface	ATA-8, SATA 2.6, 3.0 Gb/s, NCQ	
	Transfer Rate	Synchronous (maximum)	300 MB/s (Drive Capability)
	Seek Time (typical reads, including settling)	Single Track	1.5 ms
		Average	11 ms
		Maximum	22 ms
	Cache	16 MB	
	Rotational Speed	7200 rpm	
	Logical Blocks	1,465,149,168	
	Operating Temperature	32° to 140° F (0° to 60° C) [case temp]	
	Features	ATA Security	

Technical Specifications

500 GB 7200 rpm SATA Hard Drive	Drive Weight	0.25 lbs (115g)
	Capacity	500 GB
	Height	0.37 in (9.5 mm)
	Width	2.75 in (70 mm)
	Interface	ATA-8, SATA 2.6, 3.0 Gb/s, NCQ
	Transfer Rate	Synchronous (maximum) 300 MB/s (Drive Capability)
	Seek Time (typical reads, including settling)	Single Track 1.5 ms
		Average 11 ms
		Maximum 22 ms
	Cache	16 MB
	Rotational Speed	7200 rpm
	Logical Blocks	976,773,168
	Operating Temperature	32° to 140° F (0° to 60° C) [case temp]
	Features	ATA Security

500 GB 7200 rpm SMART SATA II Self Encrypting Drive	Drive Weight	0.25 lbs (115g)
	Capacity	500 GB
	Height	0.37 in (9.5 mm)
	Width	2.50 in (63.5 mm)
	Interface	ATA-8, SATA 2.6, 3.0 Gb/s
	Transfer Rate	Synchronous (maximum) 300 MB/s (Drive Capability)
	Seek Time (typical reads, including settling)	Single Track 1 ms
		Average 12 ms
		Maximum 20 ms
	Cache	16 MB
	Rotational Speed	7200 rpm
	Logical Blocks	976,773,168
	Operating Temperature	32° to 140° F (0° to 60° C) [case temp]
	Features	ATA Security

Technical Specifications

320 GB 7200 rpm SATA Hard Drive	Drive Weight	0.25 lbs (115 g)	
	Capacity	320 GB	
	Height	0.37 in (9.5 mm)	
	Width	2.75 in (70 mm)	
	Interface	ATA-8, SATA 2.6, 3.0 Gb/s, NCQ	
	Transfer Rate	Synchronous (maximum)	300 MB/s (Drive Capability)
	Seek Time (typical reads, including settling)	Single Track	1.5 ms
		Average	11 ms
		Maximum	22 ms
	Cache	16 MB	
	Rotational Speed	7200 rpm	
	Logical Blocks	625,142,448	
	Operating Temperature	32° to 140° F (0° to 60° C) [case temp]	
	Features	ATA Security	

SATA 6 Gb/s 256 GB, 2.5-inch SATA SED Solid State Drive	Drive Weight	73 Grams	
	Capacity	256 GB	
	Height	0.276 in (7 mm)	
	Width	2.76 in (70 mm)	
	Interface	SATA 3 (6 Gb/s)	
	Performance	Maximum Sequential Read	Maximum Sequential Write
		Up to 460 MB/s	Up to 260 MB/s
	Logical Blocks	500,118,192	
	Operating Temperature	32° to 158°F (0° to 70°C) [case temp]	
	Features	ATA Security; ATA-8 compliant; SATA 3.0; DIPM; TRIM	

Technical Specifications

SATA 6 Gb/s 180 GB, 2.5-inch Solid State Drive	Drive Weight	78 Grams	
	Capacity	180 GB	
	Height	0.276 in (7 mm)	
	Width	2.76 in (70 mm)	
	Interface	SATA Gen 3 (6 Gb/s)	
	Performance	Maximum Sequential Read	Maximum Sequential Write
		550 MB/s	520 MB/s
	Logical Blocks	351,651,888	
	Operating Temperature	32° to 158°F (0° to 70°C) [case temp]	
Features	ATA Security; ATA-8, SATA 3.0; DIPM; TRIM		

SATA 6 Gb/s 128 GB, 2.5-inch Solid State Drive	Drive Weight	73 Grams	
	Capacity	128 GB	
	Height	0.276 in (7 mm)	
	Width	2.76 in (70 mm)	
	Interface	SATA 3 (6 Gb/s)	
	Performance	Maximum Sequential Read	Maximum Sequential Write
		415 MB/s	175 MB/s
	Logical Blocks	250,069,680	
	Operating Temperature	32° to 158°F (0° to 70°C) [case temp]	
	Features	ATA Security; ATA-8; SATA 3.0 DIPM; TRIM	

Optical Drives

DVD-ROM Drive	Access Times	Random	< 140 ms CD (typical) < 160 ms DVD (typical)
	Max Data Transfer Rate	24X CD-ROM 8X-DVD	
	Transfer Mode	UDMA Mode 5	
	Interface	Gen 1 SATA	
	Supported Media (read)	CD-DA, CD-TEXT, CD-ROM, CD-ROM XA, MIXED MODE CD, CD-I, CD-I Bridge (Photo-CD, Video CD), Multisession CD (Photo-CD, CD-EXTRA, Portfolio, CD-R, CD-RW), CD-R, CD-RW, DVD-ROM (DVD-5, DVD-9, DVD-10, DVD-18), DVD-R, DVD-RW, DVD+R, DVD+RW, DVD-RAM	
	Supported Media (write)	None	
	Max Media Capacity (read)	8.5GB	
	Transport	Tray Loading	

Technical Specifications

DVD+/-RW SuperMulti DL Drive	Access Times	Random	<140ms CD (typical) < 160 ms DVD (typical)
	Max Data Transfer Rate	24X CD-ROM 8X DVD 24X CD-R 24X CD-RW 8X DVD+R 8X DVD+RW 8X DVD-R 6X DVD-RW 6X - DVD+R Dual Layer 6X - DVD-R Dual Layer 5X DVD-RAM	
	Transfer Mode	UDMA Mode 5	
	Interface	Gen 1 SATA	
	Supported Media (read)	CD-DA, CD-TEXT, CD-ROM, CD-ROM XA, MIXED MODE CD, CD-I, CD-I Bridge (Photo-CD, Video CD), Multisession CD (Photo-CD, CD-EXTRA, Portfolio, CD-R, CD-RW), CD-R, CD-RW, DVD-ROM (DVD-5, DVD-9, DVD-10, DVD-18), DVD-R, DVD-RW, DVD+R, DVD+RW, DVD-RAM	
	Supported Media (write)	CD-R, CD-RW, DVD+R, DVD+RW, DVD-R, DVD-RW, DVD-RAM, DVD+R DL, DVD-R DL	
	Max Media Capacity (read)	8.5 GB	
	Max Media Capacity (write)	8.5 GB	
	Transport	Tray Loading	
Blu-ray ROM DVD+/-RW SuperMulti DL Drive	Access Times	Random	<190 ms CD-ROM (typical) < 180ms DVD-ROM (typical) <230 ms BD-ROM (typical)
	Max Data Transfer Rate	24X CD-ROM 8X DVD-ROM 24X CD-R 16X CD-RW 8X DVD+R 8X DVD+RW 8X DVD-R 6X DVD-RW 4X - DVD+R Dual Layer 4X - DVD-R Dual Layer 5X DVD-RAM 6X BD-ROM	

Technical Specifications

Transfer Mode	UDMA Mode 5
Interface	Gen 1 SATA
Supported Media (read)	CD-DA, , CD-TEXT, CD-ROM, CD-ROM XA, MIXED MODE CD, CD-I, CD-I Bridge (Photo-CD, Video CD), Multisession CD (Photo-CD, CD-EXTRA, Portfolio, CD-R, CD-RW), CD-R, CD-RW, DVD-ROM (DVD-5, DVD-9, DVD-10, DVD-18), DVD-R, DVD-RW, DVD+R, DVD+RW. DVD-RAM, BD-ROM, BD-R, BD-RE
Supported Media (write)	CD-R, CD-RW, DVD+R, DVD+R DL, DVD+RW, DVD-R, DVD-R DL, DVD-RW, DVD-RAM
Max Media Capacity (read)	50.0 GB
Max Media Capacity (write)	8.5GB
Transport	Tray Loading

SECURITY

HP Fingerprint Sensor (optional)	Mobile Voltage Operation	3.0V-3.6V Single Supply
	Operating Temperature	32° - 158°F (0° - 70°C)
	Current Consumption @ 3.3V	Less than 70 mA peak imaging and scrolling Less than 25 mA hardware finger detection Advanced Power Management
	High-Rate Image Capture	Up to 240 image frames /sec
	ESD Resistance	IEC 61000-4-2 Level 4 (±15KV)
	Detection Matrix	192 x 16 Pixels 9.7 mm x 0.81 mm 500 ppi High-Resolution Images

NETWORKING/COMMUNICATIONS

Technical Specifications

Intel® 82579LM Gigabit Network Connection	Ethernet Features	<p>10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023. Clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s IEEE 802.1p QoS (Quality of Service) Support IEEE 802.1q VLAN support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable) IEEE 802.3az EEE(Energy Efficient Ethernet) Jumbo Frame 9K Auto MDI/MDIX Crossover cable detection</p>
Power Management	Power Management	<p>ACPI compliant - multiple power modes Energy Detect Low Power Mode(Green Ethernet)</p>
Performance Features	Performance Features	<p>TCP/IP/UDP Checksum Offload (configurable) Protocol Offload(ARP & NS) Large send offload and Giant send offload Receiving Side Scaling MACSec Offload (802.3ae) Intel vPro iSCSI Boot</p>
Manageability	Manageability	<p>Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status</p>
Interface	Interface	<p>PCI Express 1.1 x1 to fully support ASPM L0s/L1 and CLKREQ. NOTE: Intel 82579 PCIe interface is not PCIe compliant. It operates at half of PCIe specification V1.1 (2.5GT/S) speed.</p>
NIC Device Driver Name	NIC Device Driver Name	Intel 82579LM/82579V Ethernet Network Connection

Technical Specifications

V.92 56K Data/Fax Modem Form Factor	MDC 1.5 Daughtercard
Power Management Support	APM Revision 1.2, ACPI
Approvals/Certifications	UL, CSA, NEMKO, CCIB, Industry Canada, FCC Part 68, CTR21, FCC Part 15 Class B, Canadian ICES-003 Class B, C.I.S.P.R.22, Australian ACA, CE Mark, Other Countries
Data Mode Capabilities	V.92 data V.8bis V.80 V.44, V.42bis, MNP5 (Compression) V.42 (LAPM, MNP2-4) (Error Correction) Optional symbol rates: 2800, 3429 Asymmetric Symbol rates Synchronous primary channel data signaling rates: 3600, 31200 Automatic rate re-negotiation V.34 V.32bis V.32 V.23 V.22bis V.22 V.21 Bell 212A Bell 103J
Fax Mode Capabilities	TIA/EIA-578-B (Class 1) T.30, T.4 (Group 3) V.17 V.29 V.27ter V.21 Channel 2 T.31
Command Set	V.250 (Partial) TIA-602 Identification: +GMI, +GMM, +GMR Port control: +IPR, +ICF, +IFC, +ILRR Modulation: +MS, +MR, +MA Error control: +ES, +ER, +EB, +ESR, +ETBM Data compression: +DS, +DR V.251

Technical Specifications

HP un2430 EV-DO/HSDPA Mobile Broadband Module (Gobi™ 3000)	Technology/Operating Bands	GSM/GPRS/EDGE: 850MHz(Cell), 900MHz(EGSM), 1800MHz(DCS), 1900MHz (PCS) UMTS/WCDMA with receive diversity: 2100MHz (UTRA FDD Band I), 1900MHz (UTRA FDD Band II), AWS (UTRA FDD Band IV), 900MHz(UTRA FDD Band VIII), 850MHz (UTRA FDD Band V) 1xEVDO/1xRTT with receive diversity: 850MHz (Band Class0-Cell), 1900MHz (Band Class1-PCS)
	Wireless Protocol Standards	GSM/GPRS/EDGE: Class A, Multi-slot class 10 operation, coding schemes CS1 - CS4 and MSC1 - MSC9. UMTS/WCDMA: Release 99 and Release 6 CDMA: 1xEVDO Release 0 and Release A, IS-95A, IS-95B, IS-856, IS-2000
	Wireless Parametric Standards	Meets or exceeds TIA/EIA IS-98-D
	Maximum Data Rates	UMTS (HSPA) - 14.4 Mbps (Download), 5.76Mbps (Upload) CDMA (EVDO Release A) - 3.1 Mbps (Download), 1.8Mbps (Upload)
	GPS	Standalone GPS enabled gpsOneXTRATM™
	GPS Bands	L1 - 1575.42 MHz
	Maximum Output Power	GSM/GPRS/EDGE: 32dBm (+/-1) WCDMA: 24dBm (+0.7/-2.3) CDMA: 24dBm (+0.7/-2)
	Maximum Power Consumption	2750mA (peak); 1100mA (average)
	Power Consumption, Idle Not Connected	20 mA
	Power Management	USB selective suspend Integrated notebook wireless button
	Antenna Type	Dual high efficiency 5 band antennae with spatial diversity, mounted in the display enclosure
	Form Factor	PCI-Express MiniCard, USB 2.0 interface
	Weight	11.5 g
	Dimensions (Length x Width x Thickness)	2.01 x 1.18 x 0.18 in (51 x 30 x 5 mm)
	Voltage, Operating	3.3v +/- 10%
	Temperature, Operating (from TIA/EIA/IS-98-D)	-22° to 158° F (-30° to 70° C) (full RF performance) -22° to 167° F (-30° to 75° C) (reduced RF performance)
	Temperature, Non-operating, 96 hours (from MIL-STD 202 Method 108)	-40° to 185° F (-40° to 85° C)
	Humidity, Non-operating	95% relative humidity for 48 hours @ 185° F (85° C) (non-condensing)
	Configuration Utilities	HP Connection Manager
	LED Activity	LED Off - Radio Off; Solid LED On - Radio On

Technical Specifications

HP hs2350 HSPA+ Mobile Broadband Module	Technology/Operating Bands	GSM/GPRS/EDGE: 850MHz(Cell), 900MHz(EGSM), 1800MHz(DCS), 1900MHz (PCS) UMTS/WCDMA with receive diversity: 2100MHz (UTRA FDD Band I), 1900MHz (UTRA FDD Band II), 900MHz(UTRA FDD Band VIII), 850 MHz (UTRA FDD Band V)
	Wireless Protocol Standards	GSM/GPRS/EDGE: Class B, Multi-slot class 10 operation, coding schemes CS1 - CS4 and MSC1 - MSC9. UMTS/WCDMA: Release 99 and Release 7 Advanced Receiver Type 3i
	Wireless Parametric Standards	Complies with 3GPP specifications
	Maximum Data Rates	UMTS (HSPA) - 21 Mbps (Download), 5.76Mbps (Upload)
	GPS	Standalone, A-GPS (Internet- and Network assisted)
	GPS Bands	1575.42 MHz (± 1.023 MHz)
	Maximum Output Power	GSM/EDGE GSM850 & GSM900 bands GPRS: +33 dBm ± 2 dBm (class 4) EGPRS: +27 dBm ± 3 dBm (class E2) DCS1800 & PCS1900 bands GPRS: +30 dBm ± 2 dBm (class 1) EGPRS: +26 dBm +4 / -3 dBm (class E2)
	Maximum Power Consumption	UMTS UTRA FDD Bands +24 dBm +4 / -3 dBm (class 3) 2000mA (peak); 600mA (average)
	Power Consumption, Sleep Mode	5 mA
	Power Management	USB selective suspend Integrated notebook wireless button
	Antenna Type	Dual high efficiency 5 band antennae with spatial diversity, mounted in the display enclosure
	Form Factor	PCI-Express MiniCard, USB 2.0 interface
	Weight	< 12 g
	Dimensions (Length x Width x Thickness)	2.01 x 1.18 x 0.18 in (51 x 30 x 5 mm)
	Voltage, Operating	3.3v +/- 9%
	Temperature, Operating	14° to 149° F (-10° to 65° C) (full RF performance) 14° to 167° F (-10° to 75° C) (reduced RF performance)
	Temperature, Non-operating, 96 hours (from MIL-STD 202 Method 108)	-22° to 185° F (-30° to 85° C)
	Humidity, Non-operating	85% relative humidity for 48 hours @ 185° F (85° C) (non-condensing)
	Configuration Utilities	HP Connection Manager

Technical Specifications

LED Activity

LED Off - Radio Off;
Solid LED On - Radio On

HP It2522 LTE/EV-DO Mobile Broadband Module	Technology/Operating Bands	CDMA/1xRTT/EvDO: 800MHz (Cell), 1900MHz (PCS) GSM/GPRS/EDGE: 850MHz (Cell), 900MHz (EGSM), 1800MHz (DCS), 1900MHz (PCS) UMTS/WCDMA with receive diversity: 2100MHz (UTRA FDD Band I), 1900MHz (UTRA FDD Band II), 900MHz (UTRA FDD Band VIII), 850 MHz (UTRA FDD Band V) LTE: 700 MHz (Verizon, Band XIII)
	Mobile Operator	Verizon (US only)
	Wireless Protocol Standards	GSM/GPRS/EDGE: Class B, Multi-slot class 10 operation, coding schemes CS1 - CS4 and MSC1 - MSC9. CDMA: 1xEVDO Release 0 and Release A, IS-95A, IS-95B, IS-856, IS-2000 UMTS/WCDMA: Release 99 and Release 7 LTE: Power Class III as per 3GPP TS 36.101
	Wireless Parametric Standards	Complies with 3GPP specifications Release 8 for LTE
	Maximum Data Rates	EvDO (Revision A) - 3.1 Mbps (Download), 1.8 Mbps (Upload) WCDMA (DC-HSPA+) - 42Mbps (Download) LTE (Category 3) - 100 Mbps (Download), 50Mbps (Upload)
	GPS	Standalone, Assisted, XTRA
	GPS Bands	1575.42 MHz (± 1.023 MHz)
	Maximum Output Power	GSM/GPRS/EDGE: 32dBm (+/-1) WCDMA: 24dBm (+0.7/-2.3) LTE: +23 dBm (+2.7 dBm/-1.7 dBm) 1xRTT/EvDO: +24 dBm (+0.5 dBm/-1.5 dBm)
	Maximum Power Consumption	2700mA (peak)
	Power Consumption, Sleep Mode	10 mA
	Power Management	USB selective suspend Integrated notebook wireless button
	Antenna Type	Dual high efficiency 6 band antennae with spatial diversity, mounted in the display enclosure
	Form Factor	PCI-Express MiniCard, USB 2.0 interface
	Weight	< 10 g
	Dimensions (Length x Width x Thickness)	2.01 x 1.18 x 0.18 in (51 x 30 x 4.5 mm)
	Voltage, Operating	3.3v +/- 9%
	Temperature, Operating	-4° to 149° F (-20° to 65° C)
	Temperature, Non-operating, 96 hours (from MIL-STD 202 Method 108)	-40° to 185° F (-40° to 85° C)

Technical Specifications

Humidity, Non-operating	85% relative humidity for 48 hours @ 185° F (85° C) (non-condensing)
LED Activity	LED Off - Radio Off; Solid LED On - Radio On

HP It2523 LTE/HSPA+ Mobile Broadband Module	Technology/Operating Bands	GSM/GPRS/EDGE: 850MHz (Cell), 900MHz (EGSM), 1800MHz (DCS), 1900MHz (PCS) UMTS/WCDMA with receive diversity: 2100MHz (UTRA FDD Band I), 1900MHz (UTRA FDD Band II), 850 MHz (UTRA FDD Band V) LTE: AWS (Band IV) 700 MHz (AT&T, Band XVII)
	Mobile Operator	AT&T (US only)
	Wireless Protocol Standards	LTE: Power Class III as per 3GPP TS 36.101
	Wireless Parametric Standards	Complies with 3GPP specifications Release 8 for LTE
	Maximum Data Rates	WCDMA (DC-HSPA+) - 42Mbps (Download) LTE (Category 3) - 100 Mbps (Download), 50Mbps (Upload)
	GPS	Standalone, Assisted, XTRA
	GPS Bands	1575.42 MHz (± 1.023 MHz)
	Maximum Output Power	GSM/GPRS/EDGE: 32dBm (+/-1) WCDMA: 24dBm (+0.7/-2.3) LTE: +23 dBm (+2.7 dBm/-1.7 dBm) 1xRTT/EvDO: +24 dBm (+0.5 dBm/-1.5 dBm)
	Maximum Power Consumption	2700mA (peak)
	Power Consumption, Sleep Mode	10 mA
	Power Management	USB selective suspend Integrated notebook wireless button
	Antenna Type	Dual high efficiency 6 band antennae with spatial diversity, mounted in the display enclosure
	Form Factor	PCI-Express MiniCard, USB 2.0 interface
	Weight	< 10 g
	Dimensions (Length x Width x Thickness)	2.01 x 1.18 x 0.18 in (51 x 30 x 4.5 mm)
	Voltage, Operating	3.3v +/- 9%
	Temperature, Operating	-4° to 149° F (-20° to 65° C)
	Temperature, Non-operating, 96 hours (from MIL-STD 202 Method 108)	-40° to 185° F (-40° to 85° C)
	Humidity, Non-operating	85% relative humidity for 48 hours @ 185° F (85° C) (non-condensing)
	LED Activity	LED Off - Radio Off; Solid LED On - Radio On

Technical Specifications

Intel Centrino Advanced-N Wireless LAN Standards 6205 (2x2)	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n
Interoperability	Wi-Fi certified Cisco Compatible Extensions Program compliant with Microsoft Windows 7, Windows Vista and XP (details at: http://www.hp.com/go/notebooks/WLAN)
Frequency Band	2.4 GHz and 5GHz
Antenna Structure	2 transmit; 2 receive (2x2)
Data Rates	802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: 66 possible data rates, ranging from 6 Mbps to 300 Mbps, depending on the combination of Bandwidth, Modulation Coding Scheme, and Guard Interval used, as defined in IEEE 802.11n specification
Modulation	Direct Sequence Spread Spectrum DBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAM
Security¹	Authentication: WPA and WPA2, 802.1x (EAP_TLS, TTLS, PEAP, LEAP, EAP-FAST) Authentication Protocols: PAP, CHAP, TLS, GTC, MS-CHAP, MS-CHAPv2 Encryption: 64 and 128-bit WEP, AES-CCMP, CKIP, TKIP Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program Version 4) with Microsoft Windows Vista and XP only.
Sub-channels	Multinational support with frequency bands and channels compliant to local regulations.
Media Access Protocol	CSMA/CA (Collision Avoidance) with ACK
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between 2.4GHz band Access Points
Output Power (for CCK and OFDM) ²	17 dBm max
Power Consumption	Transmit: 2.3 Watts (max, with two spatial streams) Receive: 1 Watt (max with two spatial streams) Idle mode ³ : 35 mW (average) Radio off: 20 mW (max)
Power Management	ACPI compliant power management 802.11 compliant power saving mode
Receiver Sensitivity⁴	54 Mbps: -76 dBm, 6 Mbps: -92 dBm
Antenna Connections	2 U.FL type connectors, 50 ohm nominal impedance
Form Factor	PCI-Express Half-MiniCard
Weight	0.0075 lb (3.4 g)
Dimensions	0.12 x 1.06 x 1.18 in (3.1 x 26.8 x 30.0 mm)

Technical Specifications

Operating Voltage	3.3V +/- 9%	
Temperature	Operating	32° to 176° F (0° to 80° C)
	Non-operating	-40° to 176° F (-40° to 80° C)
Humidity	Operating	10% to 90% (non-condensing)
	Non-operating	5% to 90% (non-condensing)
Altitude	Operating	0 to 10,000 ft (3,048 m)
	Non-operating	0 to 50,000 ft (15,240 m)
LED Activity	LED Off - Radio OFF; Solid LED On - Radio ON	

1. Check latest software/driver release for updates on supported security features.
2. Maximum output power may vary by country according to local regulations.
3. In Power Save Polling mode and on battery power.
4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
5. WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista.

Intel Centrino Ultimate-N 6300	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n
	Interoperability	Wi-Fi certified Cisco Compatible Extensions Program compliant with Microsoft Windows 7, Windows Vista and XP (details at: http://www.hp.com/go/notebooks/WLAN)
	Frequency Band	2.4 GHz and 5GHz
	Antenna Structure	3 transmit; 3 receive (3x3)
	Data Rates	802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: many possible data rates, ranging from 6 Mbps to 450 Mbps, depending on the combination of Bandwidth, Modulation Coding Scheme, and Guard Interval used, as defined in IEEE 802.11n specification
	Modulation	Direct Sequence Spread Spectrum DBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAM
	Security¹	Authentication: WPA and WPA2, 802.1x (EAP_TLS, TTLS, PEAP, LEAP, EAP-FAST) Authentication Protocols: PAP, CHAP, TLS, GTC, MS-CHAP, MS-CHAPv2 Encryption: 64 and 128-bit WEP, AES-CCMP, CKIP, TKIP Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program Version 4) with Microsoft Windows Vista and XP only.
	Sub-channels	Multinational support with frequency bands and channels compliant to local regulations.

Technical Specifications

Media Access Protocol	CSMA/CA (Collision Avoidance) with ACK	
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)	
Roaming	IEEE 802.11 compliant roaming between Access Points	
Output Power (for CCK and OFDM) ²	17 dBm max	
Power Consumption	Transmit: 1.4 Watts (average, with one spatial streams) Receive: 1.3 Watts (average with two receive chains) Idle mode ³ : 30 mW (average) Radio off: 20 mW (max)	
Power Management	ACPI compliant power management 802.11 compliant power saving mode	
Receiver Sensitivity ⁴	54 Mbps: -76 dBm, 6 Mbps: -92 dBm	
Antenna Connections	3 U.FL type connectors, 50 ohm nominal impedance	
Form Factor	PCI-Express Half-MiniCard	
Weight	0.0075 lb (3.4 g)	
Dimensions	0.12 x 1.06 x 1.18 in (3.1 x 26.8 x 30.0 mm)	
Operating Voltage	3.3V +/- 9%	
Temperature	Operating	32° to 176° F (0° to 80° C)
	Non-operating	-40° to 176° F (-40° to 80° C)
Humidity	Operating	10% to 90% (non-condensing)
	Non-operating	5% to 90% (non-condensing)
Altitude	Operating	0 to 10,000 ft (3,048 m)
	Non-operating	0 to 50,000 ft (15,240 m)
LED Activity	LED Off - Radio OFF; Solid LED On - Radio ON	

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. In Power Save Polling mode and on battery power.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

5. WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista.

802.11 b/g/n WiFi Adapter (1x1)	Wireless LAN Standards	IEEE 802.11b IEEE 802.11g IEEE 802.11n
	Interoperability	Wi-Fi certified
	Frequency Band	2.4 GHz
	Data Rates	802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: many possible data rates, ranging from 6 Mbps to 300 Mbps, depending on the combination of Bandwidth, Modulation Coding Scheme, and Guard Interval used, as defined in IEEE 802.11n specification

Technical Specifications

Modulation	Direct Sequence Spread Spectrum DBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAM
Security¹	Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES, 802.1x authentication types EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-MSCHAPv2, LEAP, EAP-FAST.
Sub-channels	Multinational support with frequency bands and channels compliant to local regulations.
Media Access Protocol	CSMA/CA (Collision Avoidance) with ACK
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output²	13.5 dBm, nominal
Power Consumption	Transmit: 2.0 W (max) Receive: 1.6 W (max) Associated to Access Point, Idle: 250 mW nominal Wireless Button Off: 100 mW nominal Radio disabled: 75 mW nominal
Power Management	ACPI compliant power management 802.11 compliant power saving mode
Receiver Sensitivity³	72.2 Mbps: -70 dbm, 54 Mbps: -74 dBm, 11 Mbps: -88 dBm , 1 Mbps: -95 dBm
Antenna Connections	High efficiency antenna with spatial diversity, mounted in the display enclosure
Form Factor	PCI-Express Half-MiniCard 1.2
Weight	0.013 lb (6 g)
Dimensions	0.19 x 1.06 x 1.18 in (4.75 x 26.8 x 30 mm)
Operating Voltage	3.3v +/- 9%
Temperature	Operating 14° to 158° F (-10° to 70° C) Non-operating -40° to 176° F (-40° to 80° C)
Humidity	Operating 10% to 90% (non-condensing) Non-operating 5% to 95% (non-condensing)
Altitude	Operating 0 to 10,000 ft (3,048 m) Non-operating 0 to 50,000 ft (15,240 m)
LED Activity	LED Off - Radio OFF; Solid LED On - Radio ON

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0+EDR Wireless Technology

Bluetooth Specification	4.0+EDR Compliant
Dimensions	1.18 x 0.26 x 0.13 in (30 x 6.5 x 3.25 mm)
Frequency Band	2402 to 2480 MHz
Number of Available Channels	79 (1 MHz) available channels

Technical Specifications

Data Rates and Throughput	3 Mbps data rate; throughput up to 2.17 Mbps Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric or 1306.9 kbps symmetric
Transmit Power	-1.5 dBm to 4 dBm (Bluetooth Class II)
Receiver Sensitivity	Better than -20 dBm at 0.1 % raw bit error rate
Power Consumption	Peak (Tx) 264 mW Peak (Rx) 231 mW Sleep <1 mW
Antenna	Internally integrated within module
Range	Up 33 ft (10 m)
Electrical Interface	USB 2.0 compliant Microsoft Windows Plug and Play compliant
Bluetooth Software Supported	Broadcom Bluetooth for Windows Microsoft Windows Bluetooth Software
Link Topology	Point to Point, Multipoint Pico Nets up to 7 slaves
Security	Full support of Bluetooth Security Provisions
Power Management	Microsoft Windows ACPI, and USB Bus Support Self configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff
Certifications	All necessary regulatory approvals for supported countries, including: FCC (47 CFR) Part 15C, Section 15.247 & 15.249 ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark
Temperature	Operating -14° to 158° F (-10° to 70° C) Non-operating -40° to 212° F (-40° to 100° C)
Humidity	Operating 0% to 90% Non-operating 0% to 95%
Altitude	Operating 15,000 ft (4,572 m) Non-operating 40,000 ft (12,192 m)
Bluetooth Profiles Supported	Serial Port Profile (SPP) ¹ Service Discovery Application Profile (SDAP) Dial-Up Networking (DUN) ^{1,2} Generic Object Exchange Profile (GOEP) ^{1,2} Object Push Profile (OPP) ^{1,2} File Transfer Profile (FTP) Synchronization Profile (SYNC) Hard Copy Cable Replacement (HCRP) ^{1,2} Personal Area Networking Profile (PAN) ^{1,2} Human Interface Device Profile (HID) ^{1,2}

Technical Specifications

FAX Profile (FAX)
Basic Imaging Profile (BIP)²
Headset Profile (HSP)
Hands Free Profile (HFP)
Advanced Audio Distribution Profile (A2DP)

1. indicates the profile is supported by Microsoft Windows XP SP2

2. indicates the profile is part of Windows Vista

AUDIO/MULTIMEDIA

Hardware	Implementation	IDT 92HD87 High Definition CODEC
	Function-Key Volume Controls	Volume up, volume down, and mute
	Full Duplex	Yes
	Microphone In	Stereo
	Headphone/Line Out	Stereo
	Integrated Microphone	Yes, dual digital microphone array when equipped with optional webcam

Audio Output Quality	Frequency Response	20 Hz - 20 kHz
	Signal to Noise Ratio	>85 dB
	Total Harmonic Distortion	0.01%
	Noise Floor	-110 dB
	Play/Record Sampling Rate(s)	8 kHz - 48kHz
	DAC	16, 20 or 24-bit
	ADC	16 or 20-bit

Internal Stereo Speaker	Power Rating	2 Watts
	Impedance	4 ohms

POWER

Technical Specifications

HP 90W Smart AC Adapter (discrete configurations and configurations with integrated graphics with quad-core processor)	Dimensions	5.00 x 1.97 x 1.1 in (12.7 x 5.0 x 2.9 cm)
	Weight	0.82 lb (370 g)
	Input	100 to 240 VAC
		Input Efficiency 87% min at 115 VAC
		Input frequency range 47 to 63 Hz
	Output	Input AC current 1.5 A at 90 VAC, 0.75 A at 180 VAC PFC Version 2.4 A at 90 VAC, 1.2 A at 180 VAC NON PFC Version
		Output power 90W
		DC output 19.0V
		Hold-up time 5 msec at 115 VAC input
		Output current limit <11A, Over voltage protection- 29V max automatic shutdown
	Connector	3 pin/grounded, mates with interchangeable cords
	Environmental Design	Operating temperature 32° to 104° F (0° to 40° C)
		Non-operating (storage) temperature -4° to 149° F (-20° to 65° C)
		Altitude 0 to 10,000 ft (0 to 3,048 m)
		Humidity 20% to 80%
		Storage Humidity 10% to 90%
	EMI and Safety Certifications	CE Mark - full compliance with LVD and EMC directives; Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; MTBF- over 200,000 hours at 25°C ambient condition.

HP 65W Smart AC Adapter (Configurations with integrated graphics with dual-core processor)	Dimensions	4.17 x 1.85 x 1.1 in (10.6 x 4.7 x 2.8 cm)
	Weight	0.62 lb (280 g)
	Input	100 to 240 VAC
		Input Efficiency 87% min at 115 VAC
		Input frequency range 47 to 63 Hz
	Output	Input AC current 1.7 A at 90 VAC, 0.85 A at 180 VAC
		Output power 65W
		DC output 18.5V
		Hold-up time 5 msec at 115 VAC input
		Output current limit <11A, Over voltage protection- 29V max automatic shutdown
	Connector	3 pin/grounded, mates with interchangeable cords
	Environmental Design	Operating temperature 32° to 104° F (0° to 40° C)
		Non-operating (storage) temperature -4° to 149° F (-20° to 65° C)

Technical Specifications

EMI and Safety Certifications	Altitude	0 to 10,000 ft (0 to 3,048 m)
	Humidity	20% to 80%
	Storage Humidity	10% to 90%
	CE Mark - full compliance with LVD and EMC directives; Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; MTBF - over 200,000 hours at 25°C ambient condition.	

HP 9-cell (100 WHr) Lithium-Ion Primary battery

Dimensions (H x W x L)	0.8 x 2.4 x 8.1in (2 x 6.6 x 20.5cm)	
Weight (max)	1.1lb, (.488kg)	
Cells/Type	Lithium-Ion	
Energy	Voltage	11.25V
	Amp-hour capacity	8.85Ah
	Watt-hour capacity	100Wh
Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)
	Operating (Discharging)	14° to 122° F (-10° to 50° C)
	Non-operating	-4° to 122° F (-20° to 50° C)
Battery Re-Charge Time	System in OFF or Standby Mode	3.5 to 5 hours
	System ON	4 to 7 hours
Fuel Gauge LED	No	
Warranty	1 year	
Compatible with optional Travel Battery	Yes	

HP 6-cell (62 WHr) Lithium-Ion Primary battery

Dimensions (H x W x L)	0.8 x 2.0 x 8.3 in (2.0 x 5.1 x 21.1 cm)	
Weight (max)	0.72 lb (0.325 kg)	
Cells/Type	6-cell Lithium-Ion	
Energy	Watt-hour capacity	62Wh
Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)
	Operating (Discharging)	14° to 140° F (-10° to 60° C)
	Non-operating	-4° to 140° F (-20° to 60° C)
Battery Re-Charge Time	System in OFF or Standby Mode	2.5 hours
Warranty	1 year	
Compatible with optional Travel Battery	Yes	

Technical Specifications

HP 6-cell (55 WHr) Long Life Primary Battery	Dimensions (H x W x L)	0.8 x 1.8 x 8.0in (2.0 x 4.7 x 20.5cm)	
	Weight (max)	.72lb, (.323kg)	
	Cells/Type	Lithium-Ion	
	Energy	Voltage	10.8V
		Amp-hour capacity	5.1Ah
		Watt-hour capacity	55Wh
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)
		Operating (Discharging)	14° to 122° F (-10° to 50° C)
		Non-operating	-4° to 122° F (-20° to 50° C)
	Battery Re-Charge Time	System in OFF or Standby Mode	2.5 hours
		System ON	3 to 5 hours
	Fuel Gauge LED	No	
	Warranty	3 years	
	Compatible with optional Travel Battery	Yes	

Optional HP BB09 Ultra Extended Life Notebook Battery (secondary battery)	Dimensions (H x W x L)	1.2 x 5.9 x 11.4 in (3x15x29cm)	
	Weight (max)	1.5lb, (.682kg)	
	Cells/Type	Lithium-Ion	
	Energy	Voltage	11.25V
		Amp-hour capacity	8.85Ah
		Watt-hour capacity	100Wh
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)
		Operating (Discharging)	14° to 122° F (-10° to 50° C)
		Non-operating	-4° to 122° F (-20° to 50° C)
	Battery Re-Charge Time	System in OFF or Standby Mode	3.5 to 5 hours
		System ON	4 to 7 hours
	Fuel Gauge LED	Yes	
	Warranty	1 year	
	Compatible with optional Travel Battery	No	

Technical Specifications

Optional HP ST09 Extended Life Notebook Battery ("Travel Battery") (secondary battery)	Dimensions (H x W x L)	1.2 x 6.1 x 12 in (3x15.5x30.5cm)
	Weight (max)	1.2lb, (.550kg)
	Cells/Type	Lithium-Ion Polymer
	Energy	Voltage 11.1V
		Amp-hour capacity 6.6Ah
		Watt-hour capacity 73Wh
	Temperature	Operating (Charging) 32° to 113° F (0° to 45° C)
		Operating (Discharging) 14° to 122° F (-10° to 50° C)
		Non-operating -4° to 122° F (-20° to 50° C)
	Battery Re-Charge Time	System in OFF or Standby Mode 3.5 to 5 hours
		System ON 4 to 7 hours
	Fuel Gauge LED	Yes
	Warranty	1 year
	Compatible with optional Travel Battery	Yes

ENVIRONMENTAL

HP EliteBook 8470p Notebook PC

Environmental Data

Eco-Label Certifications	This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:		
	US ENERGY STAR qualified (with Microsoft OS) IT ECO declaration EPEAT Gold with a Microsoft OS where HP registers commercial notebook products. See http://www.epeat.net for registration status in your country. US Federal Energy Management Program (FEMP)		
System Configuration	The configuration used for the Energy Consumption and Declared Noise Emissions data is based on a "Typically Configured Notebook"		
Energy Consumption	115 VAC	230 VAC	100 VAC
Normal Operation	8.6 W	9.27 W	8.32 W
Sleep (Energy Star low power mode)	0.6 W	0.7 W	0.6 W
Off	0.61 W	0.68 W	0.58 W
Heat Dissipation*	115 VAC	230 VAC	100 VAC
Normal Operation	29.4 BTU/hr	31.7 BTU/hr	28.4 BTU/hr
Sleep	2 BTU/hr	2.3 BTU/hr	2 BTU/hr

Technical Specifications

Off

2 BTU/hr

2.3 BTU/hr

2 BTU/hr

* Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)

System Fan Off

Sound Power
(LWAd, bels)

Sound Pressure
(LpAm, decibels)

Idle

3

26

Fixed Disk
(random writes)

3.4

26

System fan is usually off except when charging the battery

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

- Mercury greater the 5ppm by weight
- Cadmium greater than 10ppm by weight

The battery type and chemistry used in the product is:

CR2032 (coin cell), Li-ion

6-cell high capacity Lithium-Ion battery (optional 8 cell available)

Additional information

This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2002/95/EC.

This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.

This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).

This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net

Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.

This product contains 0% post-consumer recycled plastic (by wt.)

This product is greater than 96.7% recycle-able when properly disposed of at end of life.

Packaging Materials

- External:
 - PAPER/Corrugated 335.7 g
- Internal:
 - PLASTIC/Polyethylene low density 13.8 g

Technical Specifications

- PLASTIC/EPE-Expanded Polyethylene 68.1 g
- PLASTIC/Polyester 6.5 g
- The PAPER/Corrugated packaging material is made from 80% recycled content.
- The PLASTIC/Polyethylene low density packaging material is made from 60% recycled content.
- The PLASTIC/EPE-Expanded Polyethylene packaging material is made from 60% recycled content.
- The PLASTIC/Polyester packaging material is made from 60% recycled content.

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

HP EliteBook 8570p Notebook PC

Environmental Data

Eco-Label Certifications

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

US ENERGY STAR qualified (with Microsoft OS)

IT ECO declaration

EPEAT Gold with a Microsoft OS where HP registers commercial notebook products. See <http://www.epeat.net> for registration status in your country. US Federal Energy Management Program (FEMP)

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data is based on a "Typically Configured Notebook"

Energy Consumption

	115 VAC	230 VAC	100 VAC
Normal Operation	13.36 W	13.65 W	13.32 W
Sleep (Energy Star low power mode)	1.22 W	1.35 W	1.21 W
Off	0.685 W	0.800 W	0.677 W

Heat Dissipation*

	115 VAC	230 VAC	100 VAC
Normal Operation	45.69 BTU/hr	46.68 BTU/hr	45.55 BTU/hr
Sleep	4.2 BTU/hr	4.6 BTU/hr	4.1 BTU/hr

Technical Specifications

Off	2.3 BTU/hr	2.7 BTU/hr	2.3 BTU/hr
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* Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)

System Fan Off	Sound Power (LWAd, bels)	Sound Pressure (LpAm, decibels)
Idle	3.0	24
Fixed Disk (random writes)	3.4	28

System fan is usually off except when charging the battery

Batteries This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

- Mercury greater the 5ppm by weight
- Cadmium greater than 10ppm by weight

The battery type and chemistry used in the product is:

CR2032 (coin cell), Li-ion
6-cell high capacity Lithium-Ion battery (optional 8 cell available)

Additional information

This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2002/95/EC.

This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.

This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).

This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net

Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.

This product contains 0% post-consumer recycled plastic (by wt.)

This product is greater than 95.7% recycle-able when properly disposed of at end of life.

Packaging Materials

- External:
 - PAPER/Corrugated 361 g
- Internal:
 - PLASTIC/Polyethylene low density 36 g

Technical Specifications

- PLASTIC/EPE-Expanded Polyethylene 28 g
- OTHER/OTHER 20 g
- PLASTIC/Polypropylene 15 g
- The PAPER/Corrugated packaging material is made from 74% recycled content.
- The PLASTIC/Polyethylene low density packaging material is made from 21.9% recycled content
- The PLASTIC/EPE-Expanded Polyethylene packaging material is made from 21.9% recycled content
- The OTHER/OTHER packaging material is made from 21.9% recycled content.
- The PLASTIC/Polypropylene packaging material is made from 21.9% recycled content

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

MATERIAL USAGE

This product does not contain any of the following substances in excess of regulatory limits (for reference of these limits please refer to the HP General Specification of the Environment

(http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants – may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBDEs)

Technical Specifications

- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBT0)
- Nickel finishes that release greater than 0.5 µgrams/cm²/week, measured according to EN 1811:1998, are not used on any product surface designed to be frequently handled or touched by users.

END-OF-LIFE MANAGEMENT AND RECYCLING

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <http://www.hp.com/go/reuse-recycle> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <http://www.hp.com/go/recyclers>. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

HEWLETT-PACKARD CORPORATE ENVIRONMENTAL INFORMATION

For more information about HP's commitment to the environment:

Global Citizenship Report

<http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html>

Environment website

<http://www.hp.com/environment>

Eco-label certifications

<http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html>

ISO 14001 certificates:

<http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html>

Options and Accessories (sold separately and availability may vary by country)

Type	Description	Part #
Memory	HP 2 GB PC3-12800 (DDR3 1600 MHz) SODIMM	H2P63AA#xxx
	HP 4 GB PC3-12800 (DDR3 1600 MHz) SODIMM	H2P64AA#xxx
	HP 8 GB PC3-12800 (DDR3 1600 MHz) SODIMM	H2P65AA#xxx
	NOTE: Full availability of 4 GB or more of memory requires Windows Vista Business 64-bit or Linux. With Windows 32-bit operating systems, the amount of usable memory is dependent upon your configuration, so that above 3 GB all memory may not be available due to system resource requirements.	
Cases	HP Deluxe 4 Wheel Roller	XW576AA
Docking	HP Display and Notebook Stand	AW662AA
	HP Dual Hinge Notebook Stand	AW661AA
	HP Adjustable Dual Display Stand	AW664AA
	HP 90W Docking Station	A7E32AA#xxx
	HP 120W Advanced Docking Station	A7E36AA#xxx
Input/Output - Mice	HP Wireless Mobile Mouse	H2L63AA
Adapters	HP 90W Slim Adapter	BT796AA#xxx
Storage - External Storage	HP Mobile USB DVDRW	A2U57AA
	SATA Upgrade Bay 500 GB 7200 rpm Hard Drive	LX733AA
Batteries	HP CC06XL Long Life Notebook Battery	QK642AA
	HP CC09 Notebook Battery	QK643AA
	HP ST09 Extended Life Notebook Battery	QK639AA
	HP BB09 Ultra Extended Life Notebook Battery	QK640AA
Health and Education	HP 20-Notebook Managed Charging Cart	QL489AA
	HP 20-Notebook Charging Cart	QL488AA
	HP 30-Notebook Managed Charging Cart	QL490AA
	HP Pocket Whiteboard	A0X37AA
Security	HP Keyed Cable Lock	BV411AA
	HP Docking Station Cable Lock	AU656AA

Options and Accessories (sold separately and availability may vary by country)

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